MITSUBISHI SEMICONDUCTOR <GaAs FET>

MGFC39V6472A

6.4 ~ 7.2GHz BAND 8W INTERNALLY MATCHED GaAs FET

DESCRIPTION

The MGFC39V6472A is an internally impedance-matched GaAs power FET especially designed for use in 6.4 ~ 7.2 GHz band amplifiers. The hermetically sealed metalceramic package guarantees high reliability.

FEATURES

Class A operation Internally matched to 50(ohm) system High output power P1dB = 8W (TYP.) @ f=6.4~7.2GHz High power gain GLP = 9 dB (TYP.) @ f=6.4~7.2GHz High power added efficiency P.A.E. = 28 % (TYP.) @ f=6.4~7.2GHz Low distortion [item -51] IM3= -45 dBc(TYP.) @Po=28dBm S.C.L.

APPLICATION

item 01: 6.4~7.2 GHz band power amplifier

item 51: 6.4~7.2 GHz band digital radio communication

QUALITY GRADE

IG

RECOMMENDED BIAS CONDITIONS

VDS = 10(V)

ID = 2.4 (A)

Refer to Bias Procedure'

RG= 50 (ohm)

ABSOLUTE MAXIMUM RATINGS (Ta=25 deg.C)

Symbol	Parameter	Ratings	Unit			
VGDO	Gate to drain voltage	-15	V			
VGSO	Gate to source voltage	-15	V			
ID	Drain current	7.5	Α			
IGR	Reverse gate current	-20	mA			
IGF	Forward gate current	42	mA			
PT	Total power dissipation *1	42.8	W			
Tch	Channel temperature	175	deg.C			
Tstg	Storage temperature	-65 / +175	deg.C			
*1 . To 25 dog C						

^{*1 :} Tc=25 deg.C

OUTLINE DRAWING Unit: millimeters 21.0 +/-0.3 0.6 +/-0.15 ZMI (2)12.9 +/-0.2 R-1.6 GATE SOURCE (FLANGE)

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ELECTRICAL CHARACTERISTICS (Ta=25 deg.C)

Symbol	Parameter	Test conditions	Limits			Unit
Symbol			Min.	Тур.	Max.	Unit
IDSS	Saturated drain current	VDS=3V, VGS=0V	-	-	7.5	Α
gm	Transconductance	VDS=3V, ID=2.2A	-	2	-	S
VGS(off)	Gate to source cut-off voltage	VDS=3V, ID=20mA	-	-	-4.5	V
P1dB	Output power at 1dB gain compression		38	39.5	-	dBm
GLP	Linear power gain	VDS=10V, ID(RF off)=2.4A, f=6.4~7.2GHz	7	9	-	dB
ID	Drain current		-	-	3	Α
P.A.E.	Power added efficiency		-	28	-	%
IM3	3rd order IM distortion *1		-42	-45	-	dBc
Rth(ch-c)	Thermal resistance *2	Delta Vf method	-	-	3.5	deg.C/W

^{*1 :} item -51, 2 tone test, Po=28dBm Single Carrier Level, f=7.2GHz, Delta f=10MHz



^{*2:} Channel to case

KTTIC http://www.kttic.com

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